

DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade with Soft Termination NPO & X7R

I nF to 4.7 uF RoHS compliant & Halogento Free



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SCOPE

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This specification describes Automotive grade X7R series chip capacitors with flexible leadfree terminations and used for automotive equipments.

<u>APPLICATIONS</u>

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- · Soldering is compliant with J-STD-020D
- · Increased mechanical performance
- · High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

GLOBAL PART NUMBER

AS <u>xxxx x x x xxx x</u> B <u>x xxx</u>

(1) (2) (3) (4) (5)

(I) SIZE - INCH BASED (METRIC)

0603 (1608) / 0805 (2012) / 1206 (3216)/ 1210 (3225)

(2) TOLERANCE

 $| = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

(4) TC MATERIAL

X7R

NPO

(5) RATED VOLTAGE

7 = 16 V

Z = 630 V

8 = 25 V

C = 1000 V

9 = 50 V

0 = 100 V

A = 200 V

Y = 250 V

(6) PROCESS

N = Class I MLCC

B = Class II MLCC

(7) CAPACITANCE VALUE

2 significant digits + number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$



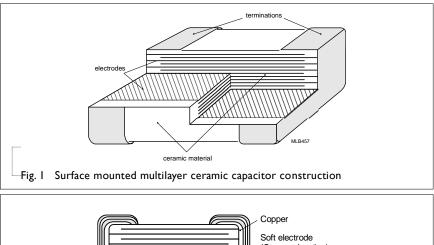
CONSTRUCTION

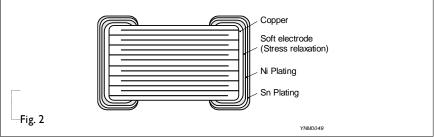
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The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end flexible terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. A cross section of the structure is shown in Fig.1 and Fig.2.



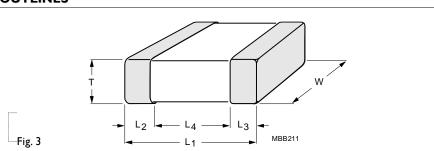


DIMENSION

Table I For outlines see fig. 3

		0				
TYPE	LI (mm)	W (mm)	T (mm)	L2/L3(mm) min	L2/L3(mm) max	L4(mm) min
0603	1.6 ± 0.2	0.8 ± 0.15	0.8 ± 0.15	0.20	0.65	0.50
0805	2.0 ± 0.3	1.25 ± 0.2	0.85 ± 0.15 0.25	0.75	0.70	
	0003 2.0 ± 0.3	1.23 ± 0.2	1.25 ± 0.20	0.23	0.73	0.70
			0.85 ± 0.15	0.25	0.85	1.50
1206	3.2 ± 0.4	1.6 ± 0.2	1.25 ± 0.20			
			1.60 ± 0.20			
			1.25 ± 0.2		1.00	
1210	1010 22 . 05	25 02	1.6 ± 0.3	0.25		1.20
1210	3.2 ± 0.5	2.5 ± 0.3	2.0 ± 0.3	0.25		1.20
		2.5 ± 0.3				

OUTLINES





1000 V

CAPACITANCE RANGE & THICKNESS FOR NPO

	630 V	630 V
CAP.	1206	1210
Table 2		

	030 V	030 1	1000 ¥
1.0 nF			
I.2 nF			
I.5 nF	1.25±0.20		
I.8 nF	1.25±0.20		
2.2 nF	1.25±0.20		
2.7 nF	1.25±0.20		
3.3 nF	1.25±0.20		
3.9 nF	1.25±0.20		
4.7 nF	1.25±0.20	1.6±0.30	2.0±0.30
5.6 nF	1.6±0.20	1.6±0.30	2.0±0.30
6.8 nF	1.6±0.20	1.6±0.30	2.0±0.30
8.2 nF	1.6±0.20	1.6±0.30	2.0±0.30
10 nF	1.6±0.20	1.6±0.30	2.5±0.30
15 nF		1.6±0.30	2.5±0.30
22 nF		2.0±0.30	2.5±0.30
33 nF		2.5±0.30	
47 nF			
NOTE	·		

NOTE

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Values in shaded cells indicate thickness class in mm

CAPACITANCE RANGE & THICKNESS FOR X7R

Table 3Size	0805						
CAP.	0603				0805		
	16 V	25 V	50 V	100 V	25 V	50 V	100 V
1.0 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
1.5 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
2.2 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
3.3 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
4.7 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
6.8 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
I0 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
15 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
22 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	0.85±0.15
33 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	1.25±0.2
47 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	0.85±0.15	0.85±0.15	1.25±0.2
68 nF	0.8±0.15	0.8±0.15	0.8±0.15		1.25±0.2	1.25±0.2	1.25±0.2
100 nF	0.8±0.15	0.8±0.15	0.8±0.15	0.8±0.15	1.25±0.2	1.25±0.2	1.25±0.2
I uF					1.25±0.2		

NOTE

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Values in shaded cells indicate thickness class in mm

off termination X7R 16 V to 250 V

CAPACITANCE RANGE & THICKNESS FOR X7R

Table 4	Size 1206 1206					1210			
	16V	25V	50 V	100 V 2	200 V / 250 V	50V	100V	200 V	250 V
22 nF			·	·	1.25±0.2	_	_		
33 nF					1.25±0.2				
47 nF					1.25±0.2				
68 nF					1.25±0.2				
100 nF		0.85±0.15	0.85±0.15	1.25±0.2	1.6±0.2		1.25±0.2	1.25±0.2	1.25±0.2
150 nF		1.25±0.2	1.25±0.2	1.25±0.2			1.25±0.2	1.25±0.2	1.25±0.2
220 nF	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2			1.25±0.2	1.25±0.2	1.25±0.2
4.7 uF						2.5±0.3			

NOTE

Values in shaded cells indicate thickness class in mm

THICKNESS CLASSES AND PACKING QUANTITY

Table 5

SIZE CODE	THICKNESS CLASSIFICATION	TAPE WIDTH QUANTITY PER REEL	Ø180 Paper	MM / 7 INCH Blister	Ø330 Paper	MM / 13 INCH Blister
0603	0.8 ±0.15 mm	8 mm	4,000		15,000	
0805	0.85 ±0.15 mm	8 mm	4,000		15,000	
0603	1.25 ±0.2 mm	8 mm		3,000		10,000
	0.6 ±0.1 mm	8 mm	4,000		20,000	
1206	0.85 ±0.1 mm	8 mm	4,000		15,000	
1206	1.25 ±0.2 mm	8 mm		3,000		10,000
	1.6 ±0.2 mm	8 mm		2,000		10,000
	1.25 ±0.2 mm	8 mm		3,000		
1210	$1.6 \pm 0.3 \text{ mm}$	8 mm		2,000		
1210	$2.0 \pm 0.3 \text{ mm}$	8 mm		2,000		
	2.5 ±0.3 mm	8 mm		1,000		



X7R

16 V to 250 V

ELECTRICAL CHARACTERISTICS

NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35°C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Tabl	e 6					
DESCRI	PTION					VALUE
Capacita	ince range					I nF to 4.7 uF
Dissipati	ion factor (D.F.)					
NP0			С	< 30 pF	≤ /	(400 + 20C)
			C	≥ 30 pF		≤ 0.1 %
Capacita	ince tolerance					
X7R					±5% (I)	, ±10%, ±20%
Dissipati	ion factor (D.F.)					
X7R		0603	0805	1206	1210	
	16V	InF to 100nF		220nF		≤ 3.5%
	25V	InF to 39nF	InF to 100nF	100nF to 220nF		≤ 2.5%
		47nF to 100nF				≤ 3.5%
			IμF			≤ 5%
	50V	InF to 39nF	InF to 100nF	100nF to 220nF		≤ 2.5%
		47nF to 100nF				≤ 3.5%
					4.7 uF	≤ 10%
	100V	InF to IOnF	InF to 100nF	100nF to 220nF		≤ 2.5%
		12nF to 100nF				≤ 5%
	200V / 250V			22nF to 100nF		≤ 2.5%
	n resistance after I at U _r (DC)			IR≥ I0 GΩ c	or I.R × C ≥ 500Ω.F wh	hichever is less
function	m capacitance change as of temperature ature characteristic/coe					±15%
Operatir NP0/X	ng temperature range: 7R					C to +125 °C

NOTE

I. Capacitance tolerance ±5% doesn't available for X7R full product range, please contact local sales force before order





X7R

16 V to 250 V

SOLDERING RECOMMENDATION

Table 7

SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 $^{\circ}\text{C}$ during 2 seconds. The test condition for no leaching is 260 $^{\circ}\text{C}$ for 30 seconds.

TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements

TEST TEST METHOD PROCEDURE		PROCEDURE	REQUIREMENTS		
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage	
Capacitance	IEC 60384- 21/22	4.5.1	At 20°C, 24 hours after annealing $f = 1$ KHz, measuring at voltage 1 V_{rms} at 20°C	Within specified tolerance	
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	At 20 °C, 24 hours after annealing $f = 1$ KHz, measuring at voltage 1 V_{rms} at 20°C	In accordance with specification	
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U _r (DC) for I minute	In accordance with specification	



16 V to 250 V

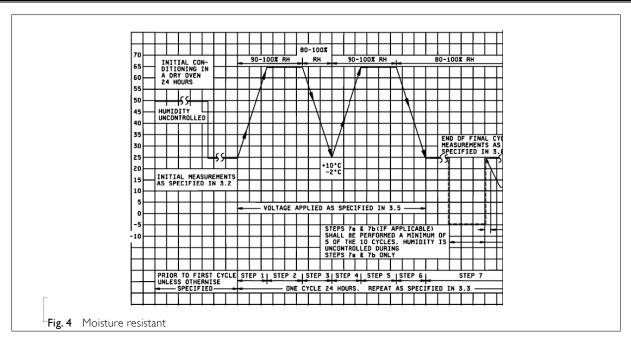
TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure	AEC-Q200	3	Unpowered ; 1000hours @ T=150°C Measurement at 24±2 hours after test conclusion.	No visual damage $\Delta C/C$ NPO: Within $\pm 2.5\%$ or 0.25 pF, whichever is greater X7R: Within $\pm 10\%$ D.F.: within initial specified value IR: within initial specified value
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/-10°C for I hour, then keep for 24 ±1 hours at room temperature 1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours	No visual damage ΔC/C NPO: Within ±2.5% or 0.25 pF, whichever is greater X7R: Within ±10% D.F. meet initial specified value IR meet initial specified value
Destructive Physical Analysis	AEC-Q200	5	Note: Only applies to SMD ceramics. Electrical test not required.	
Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage \[\Delta C/C \\ NPO: Within \pm 3\% \text{ or 3 pF, } \\ whichever is greater \\ X7R: Within \pm 15\% \] D.F. Within initial specified value IR Meet initial specified value



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TEST METHOD PROCEDURE

REQUIREMENTS



Biased Humidity

AEC-Q200

I. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for

 $24 \pm I$ hour at room temp

2. Initial measure:

Parameter: Cap, D.F., I.R.

Measuring voltage: I.5V \pm 0.1 VDC

Note: Series with 100 $\mbox{K}\Omega$

3. Test condition:

85 °C, 85% R.H. connected with 100 K Ω resistor,

applied 1.5V/Ur for 1,000 hours.

4. Recovery:

Class2: 24 ±2 hours

5. Final measure: Cap, D.F., I.R.

No visual damage after recovery

Δ C/C

NPO: Within $\pm 2\%$ or 1 pF, whichever is greater

X7R/X7S: ±15%

D.F.

Less than 200% of initial spec.

The insulation resistance shall greater than 10% of initial spec.





Surface-Mount Ceramic Multilayer Capacitors | so

oft termination	X7R	16 V to 250 V
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TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Operational Life	AEC-Q200	8	1. Preconditioning, class 2 only: 150 \pm 0/-10 °C /1 hour, then keep for 24 \pm 1 hour at room temp	No visual damage
			 Initial measure: Spec: refer to initial spec C, D, IR Endurance test: Temperature: X7R: 125 °C Specified stress voltage applied for 1,000 hours: Applied 2.0 × U_r for general products Applied 1.5 × U_r for high cap. Products High voltage series follows with below stress condition: Applied 1.5 × Ur for 200V, 250V series Applied 1.2 × Ur for 630V series Applied 1.0 × Ur for 1KV series 4. Recovery time: 24 ±2 hours 5. Final measure: C, D, IR Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met. 	ΔC/C NPO: Within ±2% or 1 pF, whichever is greater X7R/X7S: ±15% D.F. Less than 200% of initial spec. IR The insulation resistance shall be greater than 10% of initial spec.
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification
Mechanical Shock	AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Waveform: Half-sin	ΔC/C NPO: Within ± 0.5% or 0.5 pF, whichever is greater X7R/X7S: ± 10% D.F. Within initial specified value IR Within initial specified value



TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" × 5" PCB. 0.31" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.	ΔC/C NPO: Within ±0.5% or 0.5 pF, whichever is greater X7R/X7S: ±10%	
				D.F: meet initial specified value IR meet initial specified value	
Resistance to Soldering Heat	AEC-Q200	15	Precondition: $150 + 0/-10$ °C for I hour, then keep for 24 \pm I hours at room temperature Preheating: for size \leq 1206: 120 °C to 150 °C for I minute Preheating: for size \geq 1206: 100 °C to 120 °C for I minute and 170 °C to 200 °C for I minute Solder bath temperature: 260 \pm 5 °C Dipping time: 10 \pm 0.5 seconds Recovery time: 24 \pm 2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned	
				Δ C/C NPO: Within \pm 1% or 0.5 pF, whichever is greater. X7R/X7S: \pm 10%	
				D.F. within initial specified value IR within initial specified value	
Thermal Shock	AEC-Q200	16	 Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp Initial measure: Spec: refer to initial spec C, D, IR Rapid change of temperature test: 55 °C to +125 °C; 300 cycles I5 minutes at lower category temperature; I5 minutes at upper category temperature. Recovery time: Class 2: 24 ±2 hours Final measure: C, D, IR 	No visual damage ΔC/C NPO: Within ± 1% or 1 pF, whichever is greater X7R/X7S: ±15%	
				D.F: meet initial specified value IR meet initial specified value	
ESD	AEC-Q200	17	Per AEC-Q200-004	A component passes a voltage level if all components stressed at that voltage level pass.	

X7R

16 V to 250 V

TEST TEST METHOD PROCEDURE REQUIREMENTS YNM0053 6 kV DC FAIL **PASS** 2 kV 12 kV DC FAIL PASS FAIL **PASS** 1 kV 4 kV 8 kV 16 kV DC DC DC **FAIL PASS** FAIL **PASS FAIL PASS FAIL** PASS 500 V DC 25 kV 1 kV 2 kV 4 kV 6 kV 8 kV 12 kV DC DC DC DC DC AD PASS PASS FAIL FAIL 16 kV < 500 V 500 V DC DC ΑD AD

Solderability

AEC-Q200

- 18
- 1. Preheat at 155°C for 4 hours. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.
- 2. Should be placed into steam aging for 8 hours ± 15 minutes.

-Fig. 5 Passive component HBM ESD test flow diagram (DC = Direct Contact Discharge, AD = Air Discharge)

- After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.
- 3. Should be placed into steam aging for 8 hours±15 minutes.

After preheating, immerse the capacitor in a solution of Ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 120±5 seconds at 260±5°C.

The solder should cover over 95% of the critical area of each termination.

TEST	TEST METHOD	PROCEDURE	REQUIREMENT	TS
Electrical Characterization		Capacitance	NPO: V f = I MHz for C ≤ InF, measuring at voltage I V _{rms} at 25 °C to f = I±0.I KHz for C > InF, measuring at voltage I±0.2 V _{rms} at 25 °C X7R/X7S: At 25 °C, 24 hours after annealing f = I±0.I KHz, measuring at voltage I±0.2 V _{rms} at 25 °C	Within specified olerance
		Dissipation Factor (D.F.)	$f = I$ MHz for C \leq InF, measuring at voltage I V_{rms} at 25 °C $_{W}$	n accordance vith specification on Table 9
		Insulation Resistance (I.R.)	At U_r (DC) for I minute	n accordance with specification on Table 9
		Temperature coefficient	following table.	∆C/C NPO: ±30ppm °C
	AEC-Q200 19		Step Temperature(°C)	<7R: ±15% <7S: ± 22%
			(I) NPO Temperature Coefficient shall be calculated from the formula as below Temp, Coefficient = $\frac{C2 - C1}{C1 \times \Delta T} \times 10^6$ [ppm/°C] C1: Capacitance at step c C2: Capacitance at 125°C	
			Δ T: 100°C (=125°C -25°C) (2) X7R/X7S Capacitance Change shall be calculated from the formula as below $\Delta C = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c	
			C2: Capacitance at step b or d	
		Voltage Proof		No breakdown or lashover

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X7R

16 V to 250 V

PROCEDURE TEST **TEST METHOD REQUIREMENTS Board Flex** AEC-Q200 Part mounted on a 100 mm X 40 mm FR4 PCB board, which No visible damage is 1.6 ± 0.2 mm thick and has a layer-thickness 35 μm \pm 10

Part should be mounted using the following soldering reflow profile.

Conditions:

Class2:

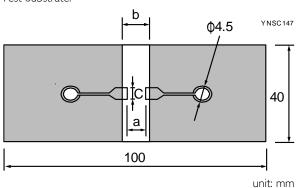
Bending 5 mm at a rate of 1 mm/s, radius jig 230 mm

 $\Delta C/C$

NPO: Within $\pm 1\%$ or 0.5 pF, whichever is greater

X7R: ±10%

Test Substrate:



	Dimension(mm)		
Type	a	b	С
0201	0.3	0.9	0.3
0402	0.4	1.5	0.5
0603	1.0	3.0	1.2
0805	1.2	4.0	1.65
1206	2.2	5.0	1.65
1210	2.2	5.0	2.0
1808	3.5	7.0	3.7

l erminal
Strength

AEC-Q200

With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested.

This force shall be applied for 60+1 seconds.

Also the force shall be applied gradually as not to apply a shock to the component being tested.

* Apply 2N force for 0402 size.

Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction.

Before and after the test, the device shall comply with all electrical requirements stated in this specification.

Beam Load Test AEC-Q200

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Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.

≤ 0805

Thickness > 0.5 mm: 20N Thickness ≤ 0.5 mm: 8N

≥ 1206

Thickness ≥1.25 mm: 54N Thickness < 1.25 mm: I5N





16 V to 250 V

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
			- Add I206/NPO/630V/I.5nF to I0nF
Version 4	May 21, 2024		- Add 1210/NPO/630V/4.7nF to 33nF
			- Add 1210/NPO/1000V/4.7nF to 22nF
Version 3	Nov. 28, 2022	-	- Update Biased Humidity and operation life requirements.
Version 2	Dec. 21, 2020	-	- Add X7R product range, 0603, InF to I5nF, I6 to I00V
Version I	Dec. 04, 2018	-	- Add 0603/ 22nF to 100nF
Version 0	Oct. 05, 2017	-	- New



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Surface-Mount Ceramic Multilayer Capacitors

Soft termination

7R

16 V to 250 V

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